



SmartFusion®2 SoC FPGAs



SmartFusion2 SoC FPGAs

More Resources in Low-Density Devices with the Lowest Power, Proven Security and Exceptional Reliability

These devices are ideal for general-purpose functions such as Gigabit Ethernet or dual PCI® Express control planes, bridging functions, input/output (I/O) expansion and conversion, video/image processing, system management and secure connectivity. Microchip FPGAs are used by customers in the communications, industrial, medical, defense and aviation markets.



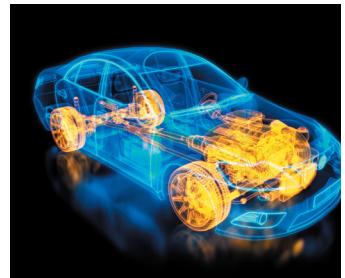
Communications



Industrial



Defense



Automotive

SmartFusion2 Advantages

More Resources in Low-Density Devices

- Arm® Cortex®-M3 with embedded flash
- PCIe Gen2 support in 10K LE
- Comprehensive microcontroller subsystem

With Clear Advantages

- Lowest Power
 - Reduces total power by up to 50%
 - 70 mW per 5G SERDES (PCIe Gen2)
- Proven Security
 - Protection from overbuilding and cloning
 - Secure boot for FPGA and processors
- Exceptional Reliability
 - SEU immune zero FIT flash FPGA configuration
 - Reliable safety-critical and mission-critical systems



Integration



Low Power



Reliability



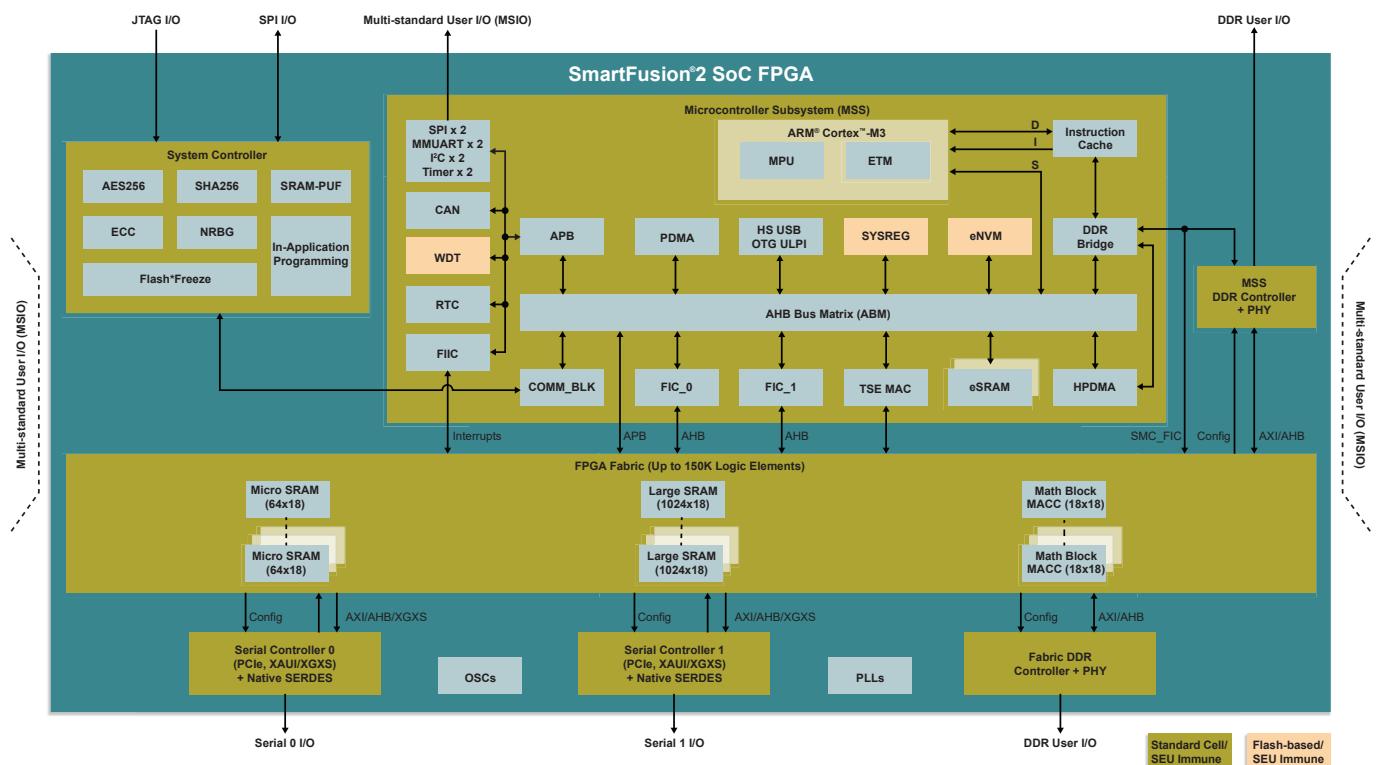
Security

SmartFusion2 FPGA Architecture

SmartFusion2 SoC FPGAs

SmartFusion2 SoC FPGAs offer 5K–150K LEs with a 166 MHz Arm Cortex-M3 processor, including ETM and instruction cache with on-chip eSRAM and eNVM, and a complete microcontroller subsystem with extensive peripherals, including CAN, TSE and USB.

- Up to 16x transceiver lanes
 - PCIe Gen2, XAUI/XGXS+, generic (EPCS) mode at 3.2G
- Up to 150K LEs, 5 Mb SRAM, 4 Mb eNVM
- Hard 667 Mbps DDR2/3 controllers
- Integrated DSP processing blocks
- Power as low as 7 mW standby, typical
- DPA-hardened, AES256, SHA256, on-demand NVM data integrity check
- SEU-protected-tolerant memories: eSRAMs, DDR bridges



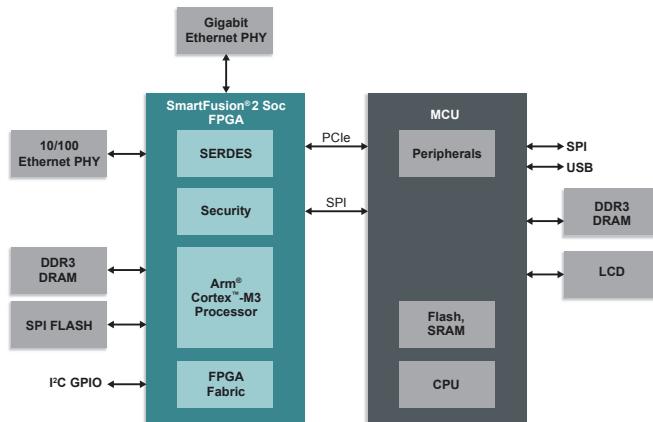
AES	Advanced Encryption Standard
AHB	Advanced High-Performance Bus
APB	Advanced Peripheral Bus
AXI	Advanced eXtensible Interface
COMM_BLK	Communication Block
DDR	Double Data Rate
DPA	Differential Power Analysis
ECC	Elliptical-Curve Cryptography
EDAC	Error Detection and Correction
ETM	Embedded Trace Macrocell
FDDR	DDR2/3 Controller in FPGA Fabric
FIC	Fabric Interface Controller
FIIC	Fabric Interface Interrupt Controller
HS USB OTG	High-Speed USB (2.0) On-The-Go
IAP	In-Applications Programming
MACC	Multiple-Accumulate

MDDR	DDR2/3 Controller in MSS
MMUART	Multi-Mode UART
MPU	Memory Protection Unit
MSS	Microcontroller Subsystem
SECDED	Single Error Correct Double Error Detect
SEU	Single Event Upset
SHA	Secure Hashing Algorithm
SMC_FIC	Soft Memory Controller
TSE	Tiple Speed Ethernet (10/100/1000 Mbps)
ULPI	UTMI + Low Pin Interface
UTMI	USB 2.0 Transceiver Macrocell Interface
WDT	Watchdog Timer
XAUI	10 Gbps Attachment Unit Interface
XGMII	10 Gigabit Media Independent Interface
XGXS	XGMII Extended Sublayer



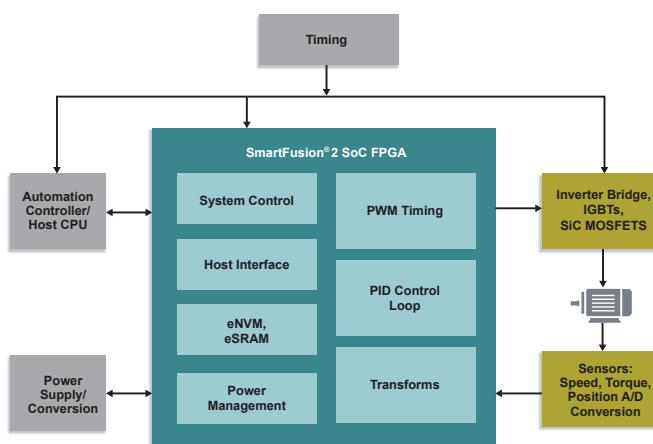
PCIe 1G Control Plan

- PCIe Gen2 in 10K LE devices with I/O expansion



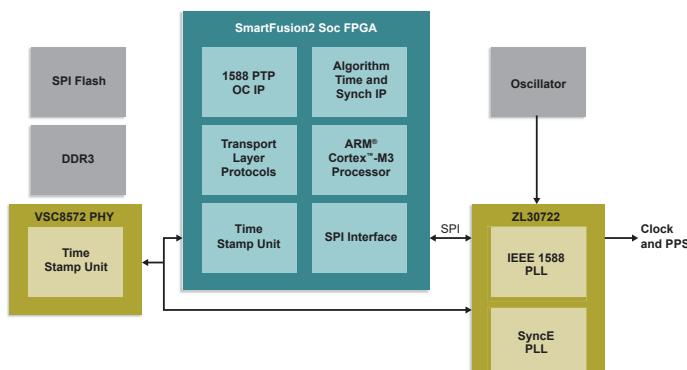
Multi-Axis Motor Control

- Deterministic and secure multi-axis/high-RPM solutions
- Motor-control IP and development kit



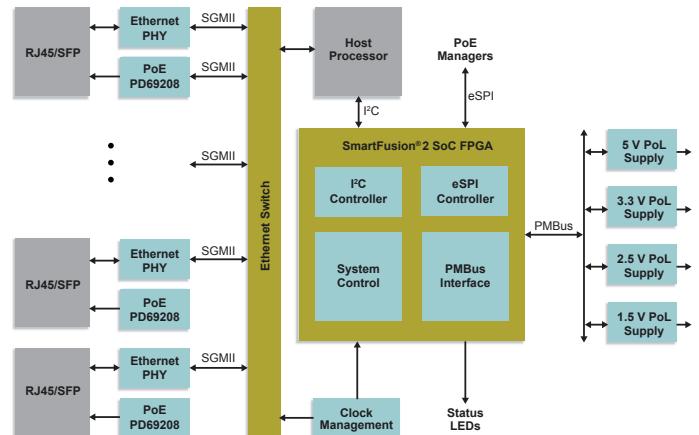
IEEE 1588 Slave/Client

- IEEE 1588 and small form factor, Cortex-M3, low power



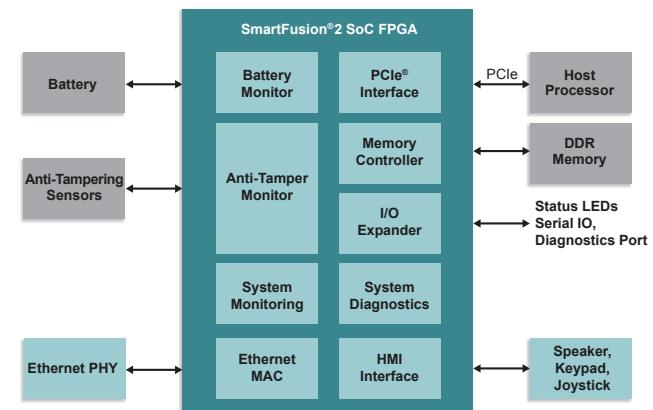
Board Initialization

- PMBus, instant-on and MSS peripherals



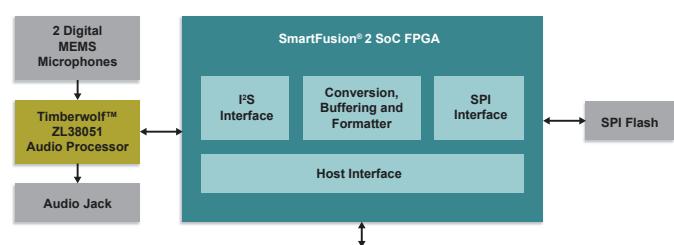
Secure Connectivity: Gaming

- Security, anti-tamper and Ethernet MAC low power



Audio Processing, Storage and Retrieval

- I²S and SPI bridge allows multiple audio recordings and playbacks

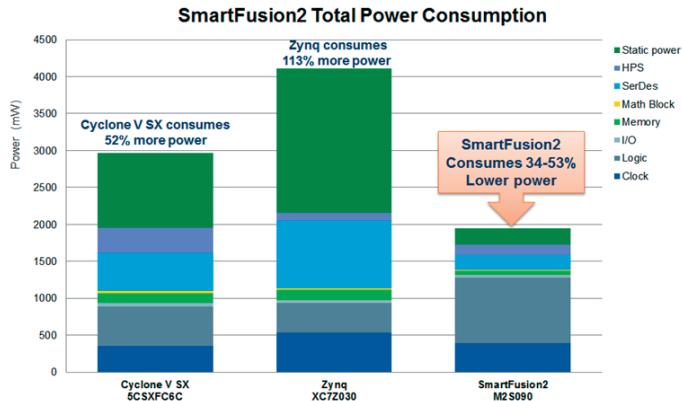


Clear Advantages

Low Power

SmartFusion2 Reduces Total Power

- Flash FPGAs deliver lowest power without sacrificing performance
- 70 mW per 5G SERDES (PCIe Gen2)
- Flash*Freeze ultra-low-power mode 12 mW



Proven Security

Protect Systems from Over-building and Cloning

- HSMs protection from overbuilding
- DPA countermeasures protect bitstream from cloning
- Only FPGA vendor with validated DPA countermeasures
- Secure boot for FPGAs and processors

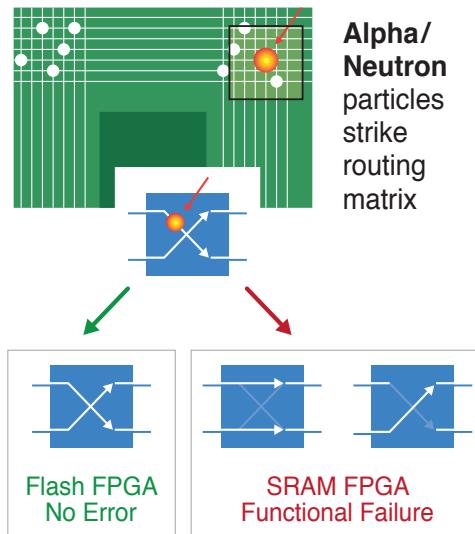


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Exceptional Reliability

- Error-free SEU immune fabric configuration
- No scrubbing required
- All SoC memory SEU-protected
- Built-in error detection and correction
- SEU-tolerant implementation
- Devices deployed in safety-critical and mission-critical systems

SRAM Configuration Failures



Design Resources

The Libero® SoC Design Suite enables high productivity with its comprehensive, easy-to-learn, easy-to-adopt development tools for designing with Microchip's power-efficient SmartFusion2, IGLOO®2, and RTG4™ FPGAs. The suite integrates industry-standard Synopsys Synplify Pro® synthesis and Mentor Graphics ModelSim® simulation tools with best-in-class constraints management, debug capabilities, and secure production programming support.

Libero SoC Design Suite provides a comprehensive design flow including traditional FPGA design flow, embedded design flow and graphical configurators. FPGA design flow is the standard VLSI design flow starting from design entry till programming and debug. The embedded design flow enables development of embedded processing solutions for high performance and high reliability applications using low-power SoC FPGAs and FPGAs. It provides comprehensive development environment to build embedded solutions using hard core and soft core processors. Graphical configurators provide a user friendly design entry approach for various peripherals, applications and solutions.



For more information, please see the following website:

<http://www.microsemi.com/products/fpga-soc/design-resources/design-software/libero-soc#downloads>

Software IDE	SoftConsole	Keil MDK	IAR Embedded Workbench®
Free Versions from Microchip	Free with Libero® SoC	32K Code Limited	32K Code Limited
Available from Vendor	N/A	Full Version	Full Version
Compiler	GNU GCC	RealView® C/C++	IAR Arm® Compiler
Debugger	GDB Debug	μVision Debugger	C-SPY® Debugger
Instruction Set Simulator	No	μVision Simulator	Yes
Debug Hardware	FlashPro4	ULINK®2 or ULINK-ME	J-LINK™ or J-LINK Lite
Trace Capability	No	ULINKpro	JTAGjet-Trace

Intellectual Property

Microchip enhances your design productivity by providing an extensive suite of proven and optimized IP cores for use with Microchip FPGAs. Our extensive suite of IP cores covers all key markets and applications. Our cores are organized into Microchip-developed DirectCores and third-party-developed CompanionCores. Most DirectCores are available for free within our Libero tool suite and include common communications interfaces, peripherals and processing elements.

<http://www.microsemi.com/products/fpga-soc/design-resources/ip-cores>

Functionality	DirectCore Examples	Functionality	CompanionCore Examples
Connectivity	UART, 16550, 429, PCI, JESD204B	Connectivity	CAN, CAN FD, PCIe, VME
DSP	CIC, FFT, FIR, CORDIC, RS	DSP	FFT, JPEG, RS, DVBMOD
Memory Controller	FIFO, DDR, QDR, SDR, MemCtrl, MMC	Memory Controller	SDRAMDDR, Flash, SD
Processor	8051, 8051s, ARM7TDMI	Processor	80188, 80186, LEON3, 6809
Ethernet	MII, RGMII, GMII, SGII	Security	MD5, ARC4, RNG, ZUC, AES, SHA, 802.1ae (MACSec)
Security	DES, 3DES, AES, SHA		

Product Family

SmartFusion2 Product Family

SmartFusion2	Features	M2S005	M2S010	M2S025	M2S050	M2S060	M2S090	M2S150
Logic/DSP	Maximum Logic Elements (4LUT + DFF)	6,060	12,084	27,696	56,340	56,520	86,316	146,124
	Math Blocks (18x18)	11	22	34	72	72	84	240
	Fabric Interface Controllers (FICs)		1		2		1	2
	PLLs and CCCs		2			6		8
	Security			AES256, SHA256, RNG			AES256, SHA256, RNG, ECC, PUF	
MSS	Cortex®-M3 + Instruction Cache				Yes			
	eNVM (KBytes)	128		256			512	
	eSRAM (KBytes)			64				
	eSRAM (KBytes) Non-SECDED			80				
	CAN, 10/100/1000 Ethernet, HS USB			1 Each				
Fabric Memory	Multi-Mode UART, SPI, I²C Timer				2 Each			
	LSRAM 18K Block	10	21	31		69	109	236
	uSRAM 1K Blocks	11	22	34		72	112	240
High Speed	Total RAM (Kbits)	191	400	592		1,314	2,074	4,488
	DDR Controllers (count x width)		1 x 18		2 x 36		1 x 18	2 x 36
	SERDES Lanes	0		4	8		4	16
	PCIe® End Point	0		1		2		4
User I/O	MSIO (3.3V)	115	123	157	139	271	309	292
	MSIOD (2.5V)	28		40	62		40	106
	DDRIO (2.5V)	66		70	176		76	176
	Total User I/Os	209	233	267	377	387	425	574

I/Os Per Package

Package Types	FCS(G)325	VF(G)256	FCS(G)536	VF(G)400	FCV(G)484	TQ(G)144	FG(G)484	FG(G)676	FG(G)896	FC(G)1152
Pitch (mm)	0.5	0.8	0.5	0.8		0.5	1.0	1.0	1.0	1.0
Length x Width (mm)	11 x 11	14 x 14	16 x 16	17 x 17	19 x 19	20 x 20	23 x 23	27 x 27	31 x 31	35 x 35
Device	I/O	Lanes	I/O	Lanes	I/O	Lanes	I/O	Lanes	I/O	Lanes
M2S005 (S)		161			171	—	84	209	—	
M2S010 (S/T/TS)		138	2		195	4	84	233	4	
M2S025 (T/TS)	180	2	138	2	207	4		267	4	
M2S050 (T/TS)	200	2			207	4		267	4	377 8
M2S060 (T/TS)	200	2			207	4		267	4	387 4
M2S090 (T/TS)	180	4						267	4	425 4
M2S150 (T/TS)			293	4	248	4				574 16

Note: 090 FCSG325 is 11x13.5 package dimension

Support

Microchip is committed to supporting its customers in developing products faster and more efficiently. We maintain a worldwide network of field applications engineers and technical support ready to provide product and system assistance. For more information, please visit www.microemi.com/fpga:

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If additional training interests you, Microchip offers several resources including in-depth technical training and reference material, self-paced tutorials and significant online resources.

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